

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHIA-LING HSU	07/26/2012
RECEIVING PARTY DATA	
Name:	HON HAI PRECISION INDUSTRY CO., LTD.
Street Address:	66, Chung Shan Road, Tu-Cheng Dist.
City:	New Taipei
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13952868
CORRESPONDENCE DATA	
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NAME OF SUBMITTER:	Clifford O. Chi
Signature:	/Clifford O. Chi/
Date:	07/29/2013
Total Attachments: 2 source=US50100130726ASM#page1.tif source=US50100130726ASM#page2.tif	

CH \$40.00 13952868

ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

- 1. CHIA-LING HSU , residing at Tu-Cheng, New Taipei, Taiwan
- 2. _____ , residing at _____
- 3. _____ , residing at _____
- 4. _____ , residing at _____
- 5. _____ , residing at _____
- 6. _____ , residing at _____
- 7. _____ , residing at _____
- 8. _____ , residing at _____

hereby sell(s), assign(s) and transfer(s) unto: HON HAI PRECISION INDUSTRY CO., LTD. having a principal place of business at 66, Chung Shan Road, Tu-Cheng Dist., New Taipei City, Taiwan, R.O.C. hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as METHOD FOR MANUFACTURING A MOLDING CORE for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____
[x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

1.	<u>Chia-Ling Hsu</u> CHIA-LING HSU	<u>2013. Jul. 26</u> Date
2.	_____	_____ Date
3.	_____	_____ Date
4.	_____	_____ Date
5.	_____	_____ Date
6.	_____	_____ Date
7.	_____	_____ Date
8.	_____	_____ Date
9.	_____	_____ Date